



PRELIMINARY

| V _{(BR)DSX} / V _{(BR)DGX} | R _{DS(on)} (max) | I _{DSS} (min) | Package |
|--|------------------------------|------------------------|---------|
| 350V _P | 30Ω | 140mA | SOT-89 |

Features

- Low $R_{DS(on)}$ at Cold Temperatures $R_{DS(on)} 30\Omega$ max. at 25°C
- High Input Impedance
- High Breakdown Voltage: 350V_P
- Low V_{GS(off)} Voltage: -1.6 to -3.9V
- Small Package Size: SOT-89

Applications

- Ignition Modules
- Normally-On Switches
- Solid State Relays
- Converters
- Telecommunications
- Power Supply

Description

The CPC3730 is an N-channel, depletion mode, field effect transistor (FET) that utilizes Clare's proprietary third-generation vertical DMOS process. The third-generation process realizes world class, high voltage MOSFET performance in an economical silicon gate process. Our vertical DMOS process vields a robust device, with high input impedance, for use in high power applications. The CPC3730 is a highly reliable FET device that has been used extensively in Clare's solid state relays for industrial and telecommunications applications.

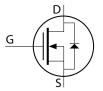
This device excels in power applications requiring low drain-source resistance, particularly in cold environments such as automotive ignition modules. The CPC3730 offers a low, 30Ω maximum, on-state resistance at 25°C.

The CPC3730 has a minimum breakdown voltage of $350V_{P}$, and is available in an SOT-89 package. As with all MOS devices, the FET structure prevents thermal runaway and thermal-induced secondary breakdown.

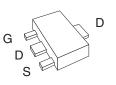
Ordering Information

| Part # | Description |
|------------|--|
| CPC3730C | N-Channel Depletion Mode FET, SOT-89 Pkg. Cut-Tape, Available in Quantities of 200, 300, 400, 500, and 600 |
| CPC3730CTR | N-Channel Depletion Mode FET, SOT-89 Pkg. Tape and Reel (1000/Reel) |

Circuit Symbol







(SOT-89)





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Absolute Maximum Ratings @ 25°C

| Parameter | Ratings | Units |
|---------------------------|------------------|----------------|
| Drain-to-Source Voltage | 350 | V _P |
| Gate-to-Source Voltage | ±15 | V _P |
| Pulsed Drain Current | 600 | mA |
| Total Package Dissipation | 1.4 ¹ | W |
| Junction Temperature | 150 | O° |
| Operational Temperature | -55 to +125 | °C |
| Storage Temperature | -55 to +125 | 0° |

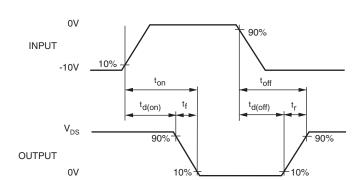
Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

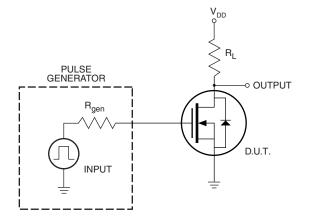
¹ Mounted on FR4 board 1"x1"x0.062"

Electrical Characteristics @ 25°C (Unless Otherwise Noted)

| Parameter | Symbol | Conditions | Min | Тур | Max | Units |
|---|---------------------------|---|-------|-----|------|----------------|
| Drain-to-Source Breakdown Voltage | V _{(BR)DSX} | V _{GS} = -5V, Ι _D =100μΑ | 350 | - | - | V _P |
| Gate-to-Source Off Voltage | V _{GS(off)} | I _{DS} = 5V, I _D =1mA | -1.6 | - | -3.9 | V |
| Change in $V_{GS(off)}$ with Temperatures | dV _{GS(off)} /dT | V _{DS} = 5V, I _D =1µA | - | - | 4.5 | mV/°C |
| Gate Body Leakage Current | I _{GSS} | V _{GS} =±15V, V _{DS} =0V | - | - | 100 | nA |
| Drain-to-Source Leakage Current | 1 | V _{GS} = -5V, V _{DS} =350V | - | - | 1 | μΑ |
| Dialit-10-Source Leakage Current | D(off) | V _{GS} = -5V, V _{DS} =280V, T _A =125°C | - | - | 1 | mA |
| Saturated Drain-to-Source Current | I _{DSS} | V _{GS} = 0V, V _{DS} =15V | 140mA | - | - | mA |
| Static Drain-to-Source On-State Resistance | R _{DS(on)} | V _{GS} = 0V, I _D =140mA | - | - | 30 | Ω |
| Change in R _{DS(on)} with Temperatures | dR _{DS(on)} /dT | V _{GS} = 0V, I _D =140mA | - | - | 1.1 | %/°C |
| Forward Transconductance | G _{FS} | I _D = 100mA, V _{DS} = 10V | 150 | - | - | mΩ |
| Input Capacitance | C _{ISS} | V _{GS} = -5V | | 100 | 200 | |
| Common Source Output Capacitance | C _{OSS} | $V_{DS} = 25V$ | - | 20 | 100 | pF |
| Reverse Transfer Capacitance | C _{RSS} | f= 1MHz | | 5 | 80 | 1 |
| Turn-On Delay Time | t _{d(on)} | V _{DD} = 25V | | 20 | | |
| Rise Time | t _r | $I_{\rm D}$ = 150mA | | 10 | | |
| Turn-Off Delay Time | t _{d(off)} | $V_{GS} = 0V \text{ to } -10V$ | - | 20 | - | ns |
| Fall time | t _r | $R_{gen} = 50\Omega$ | | 50 | | |
| Source-Drain Diode Voltage Drop | V _{SD} | V _{GS} = -5V, I _{SD} = 150mA | - | 0.6 | 1.8 | V |
| Thermal Resistance (Junction to Ambient) | R _{eja} | - | - | 90 | - | °C/W |

Switching Waveform & Test Circuit







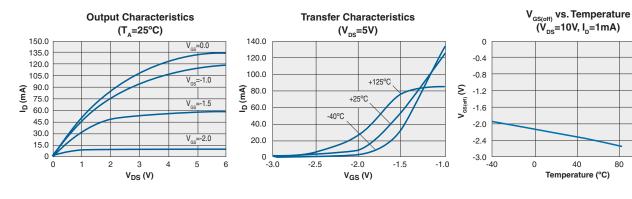
CPC3730

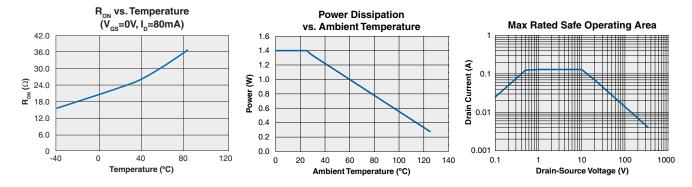
120

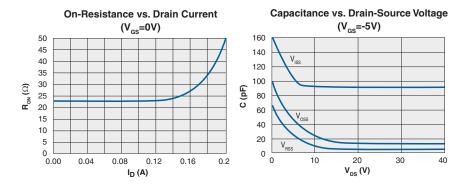
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PERFORMANCE DATA*







*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.



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Manufacturing Information

Moisture Sensitivity

All plastic encapsulated semiconductor packages are susceptible to moisture ingression. Clare classified all of its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, **IPC/JEDEC J-STD-020**, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a **Moisture Sensitivity Level (MSL) rating** as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

| Device | Moisture Sensitivity Level (MSL) Rating |
|----------|---|
| CPC3730C | MSL 1 |

ESD Sensitivity



This product is ESD Sensitive, and should be handled according to the industry standard JESD-625.

Reflow Profile

This product has a maximum body temperature and time rating as shown below. All other guidelines of **J-STD-020** must be observed.

| Device | Maximum Temperature x Time |
|----------|----------------------------|
| CPC3730C | 260°C for 30 seconds |

Board Wash

Clare recommends the use of no-clean flux formulations. However, board washing to remove flux residue is acceptable, and the use of a short drying bake may be necessary. Chlorine-based or Fluorine-based solvents or fluxes should not be used. Cleaning methods that employ ultrasonic energy should not be used.



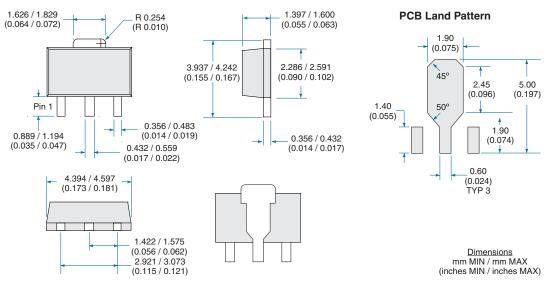


CPC3730

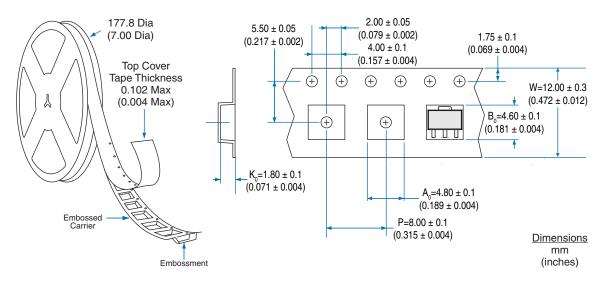
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MECHANICAL DIMENSIONS

CPC3730C



CPC3730C Tape & Reel



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